

**Bi-CMOS LSI** 

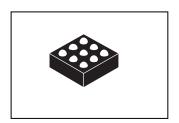
# **Dual channel LED Boost Driver** with PWM and 1-Wire Dimming

#### **Overview**

The LV52207NXA is a high voltage boost driver for LED drive with 2 channels adjustable constant current sources.

#### **Function**

- Operating Voltage from 2.7V to 5.5V
- Integrated 40V MOSFET
- 1-Wire 255 level digital and PWM dimming
- Supports CABC
- 600kHz Switching Frequency
- 37.5V OVP Threshold



WLP9, 1.31x1.31, 0.4mm pitch (1.31mm x 1.31mm, Amax=0.625 mm)

# **Typical Applications**

LED Display Backlight Control

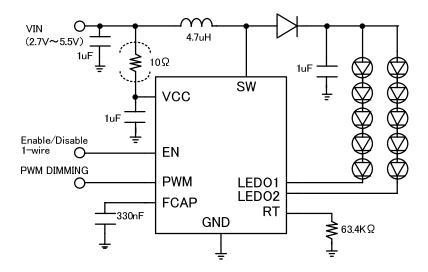


Fig1. 5x2 LED Application

#### ORDERING INFORMATION

See detailed ordering and shipping information on page 18 of this data sheet.

## **Specifications**

**Absolute Maximum Ratings** at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage voltage	VCC max	VCC	6	V
Maximum Pin voltage1	V1 max	SW	40	V
Maximum Pin voltage2	V2 max	Other pin	5.5	V
Allowable power dissipation	Pd max	Ta=25°C *1	0.95	W
Operating temperature	Topr		−40 to +85	°C
Storage temperature	Tstg		−55 to +125	°C

<sup>\*1</sup> Mounted on a specified board: 70mm×70mm×1.6mm (4 layer glass epoxy)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **Recommended Operating Conditions** at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage range1	V <sub>CC</sub> op	VCC	2.7 to 5.5	V
PWM frequency	Fpwm	PWM pin input signal	300 to 100k	Hz
MIN DUTY (PWM pin)	Dminpwm	PWM pin input signal	0.9%	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### **Electrical Characteristics Analog block**

at Ta=25°C, VCC=3.6V, RT resistor=63.4K $\Omega$  unless otherwise specified

Parameter	Symbol	Conditions		Ratings		Unit	
		Conditions	min	typ	max	Offic	
Standby current dissipation	lcc1	EN=PWM=L		0	2	μА	
DC/DC current dissipation1	lcc2	Device enable, switching 0.6 MHz and no load		0.7	1.2	mA	
FB Voltage	Vfb	LEDO1, 2=20mA		0.2		V	
Output Current1	lo1	LEDO1 LEDO2 LEDISET=20mA Duty=100%	19.6	20	20.4	mA	
Output Current Matching1	lom1	LEDO1 LEDO2 LEDISET=20mA Duty=100% (IMAX – IAVG) / IAVG		0.3	2	%	
LEDO1, 2 max current	Imax	LEDO1 LEDO2	40			mA	
LEDO1, 2 leak current	llk	LEDO1 LEDO2			1	μΑ	
OVP Voltage	Vovp	SW_pin over voltage threshold	36	37.5	39	V	
LEDO_OVP Voltage	VLovp	LEDO_pin over voltage threshold LEDO_DC rising	4.2	4.5	5.0	٧	
SWOUT ON resistance	Ron	IL=100mA		300		mΩ	
NMOS Switch Current Limit	ILIM		1	1.5		А	
OSC Frequency	Fosc		500	600	750	kHz	
High level input voltage	VINH	EN PWM	1.2		Vcc	V	
Low level input voltage	VINL	EN PWM	0		0.4	V	
Under Voltage Lockout	Vuvlo	VIN falling		2.2		V	
EN pin output voltage for Acknowledge	Vack	Rpullup=15kΩ			0.4	V	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Caution 1) Absolute maximum ratings represent the values which cannot be exceeded for any length of time.

Caution 2) Even when the device is used within the range of absolute maximum ratings, as a result of continuous usage under high temperature, high current, high voltage, or drastic temperature change, the reliability of the IC may be degraded. Please contact us for the further details.

# **Recommended EN PWM Timing** at Ta=25°C, V<sub>CC</sub>=3.6V, unless otherwise specified

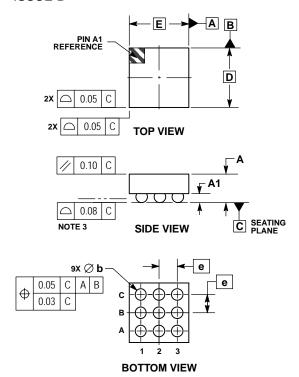
Parameter	Cumbal	Conditions		Ratings		Unit	
Parameter Symbol		Conditions	min	typ	max	Offic	
Dimming mode selectable time	Tsel		1		2.2	ms	
Delay time to start digital mode detection	Tw0		100			μS	
Low time to switch to digital mode	Tw1		260			μS	
EN pin low time to shutdown	Toffen		2.5			ms	
PWM pin low time to shutdown	Toffpwm		20			ms	
1-wire start time for digital mode programming	Tstart		2			μs	
1-wire end time for digital mode programming	Tend		2		360	μS	
1-wire High time of bit 0	Th0	Bit detection=0	2		180	μS	
1-wire Low time of bit 0	TI0	Bit detection=0	Th0 × 2		360	μS	
1-wire High time of bit 1	Th1	Bit detection=1	Tl1 × 2		360	μS	
1-wire Low time of bit1	TI1	Bit detection=1	2		180	μS	
DCDC startup delay	Tdel			5		ms	
Delay time of Acknowledge	Tackd				2	μS	
Duration of Acknowledge	Tack				512	μS	

## **Package Dimensions**

unit: mm

# WLCSP9, 1.31x1.31

CASE 567HX **ISSUE B** 



#### NOTES:

- NOTES:

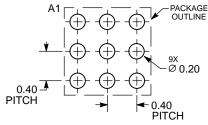
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

  2. CONTROLLING DIMENSION: MILLIMETERS.

  3. COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE SOLDER BALLS.

	MILLIMETERS					
DIM	MIN MAX					
Α		0.625				
A1	0.16	0.26				
b	0.21	0.31				
D	1.31 BSC					
E	1.31 BSC					
е	0.40 BSC					

# RECOMMENDED SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

#### LV52207NXA is as follows.

#### MARKING DIAGRAM

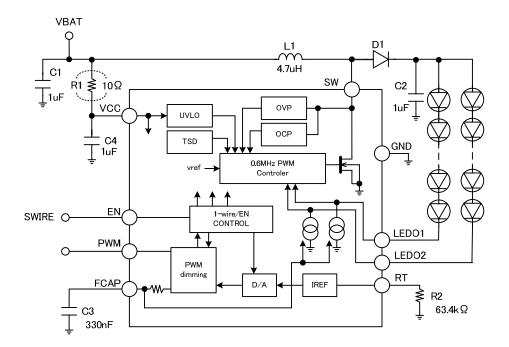


D7 = Device Code

YXX = Assembly Lot Code

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# **Block Diagram**



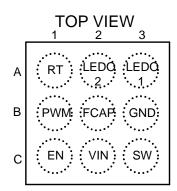
L1: VLS3012E-4R7M (TDK), VLF504015-4R7(TDK) VLS3012E-100M (TDK), VLF504015-100M(TDK)

D1: MBR0540T1 (ON semi), NSR05F40 (ON semi)

C2: GRM21BR71H105K (Murata), C1608X5R1H105K (TDK)

Fig2. Block Diagram

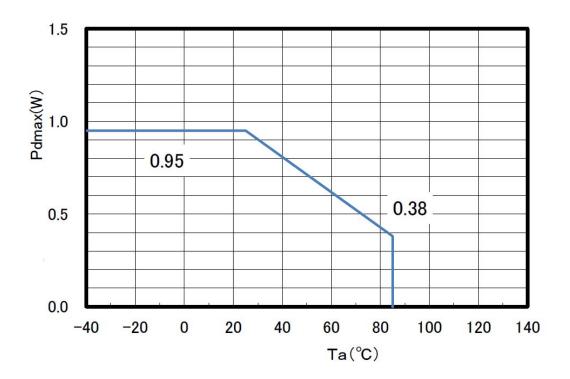
## **Pin Connection**



# **Pin Function**

PIN#	Pin Name	Description
A1	RT	Connecting a resistor terminal for Full scale LED current setting
A2	LEDO2	Constant Current Output_pin2
А3	LEDO1	Constant Current Output_pin1
B1	PWM	PWM dimming input (active High).
B2	FCAP	Filtering capacitor terminal for PWM mode
В3	GND	Ground
C1	EN	1-wire control and Enable control input (active High).
C2	VIN	Supply voltage.
C3	SW	Switch pin. Drain of the internal power FET.

# Pd-Max



Mounted on a specified board : 70mm×70mm×1.6mm (4 layer glass epoxy)

#### **LED Current Setting (max sink current)**

LED\_full current is set by an external resistor connected between the RT pin and ground.

I(LED full)=  $2113 \times (V(RT)/R(RT res))$ 

V(RT) : RT\_pin DC Voltage typ=0.6V

 $R(RT_{res})$  :  $RT_{pin}$  resistor

 $RT_res=63.4k\Omega : I(LED_full)=20mA$ 

#### **BRIGHTNESS CONTROL**

The LV52207NXA controls the DC current of the dual channels. The DC current control is normally referred to as analog dimming mode.

The LV52207NXA can receive digital commands at the EN pin (1-wire digital interface) (**Digital Mode**) and the PWM signals at the PWM pin (PWM interface) (**PWM Mode**) for brightness dimming.

## **Dimming Mode Selection**

Dimming Mode is selected by a specific pattern of the EN pin within Tsel(1ms) from the startup of the device every time.

#### **Digital Mode**

To enter Digital Mode, EN pin should be taken high for more than  $Tw0(100\mu s)$  from the first rising edge and keep low state for  $Tw1(260\mu s)$  before Tsel(1ms). When using Digital mode, the PWM pin should be kept high.

It is required sending the device address byte and the data byte to select LEDI. The bit detection is determined by the ratio of Th and Tl(See Fig5). The start condition for the bit transmission required EN pin high for at least Tstart. The end condition is required EN pin low for at least Tend. When data is not being transferred, EN pin is set in the "H" state. These registers are initialized with shutdown.

## Start up and Shutdown

The device becomes enabled when EN pin is initially taken high. The dimming mode is determined within Tsel and the boost converter start up after Tdel. To place the device into shutdown mode, the SWIRE must be held low for Toff.

#### **Digital MODE**

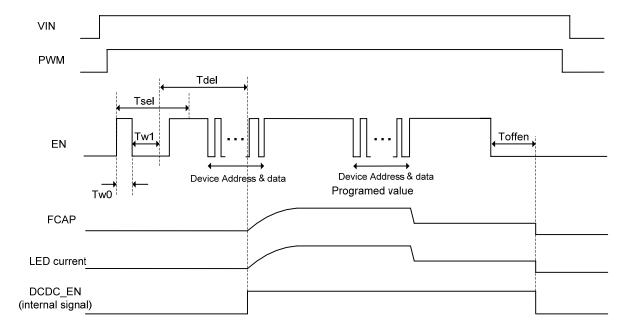


Fig3. Start up and shutdown diagram (DIGITAL MODE)

## 1-Wire Programming

Figure 15 and Table 2 give an overview of the protocol used by LV52207NXA. A command consists of 24 bits, including an 8-bit device address byte and a 16-bit data byte. All of the 24 bits should be transmitted together each time, and the LSB bit should be transmitted first. In the LV52207NXA, the device address (DA7(MSB)to DA0(LSB)) is specified as "10001111". AKct is setting for the acknowledge response. If the device address and the data byte are transferred on AKct=1, the ACK signal is sent from the receive side to the send side. The acknowledge signal is issued when EN pin on the send side is released and EN pin on the receive side is set to low state.

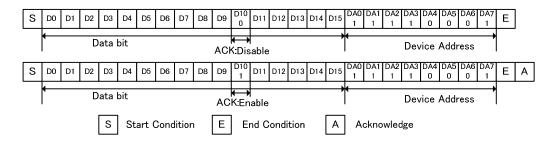


Fig4. Example of writing data

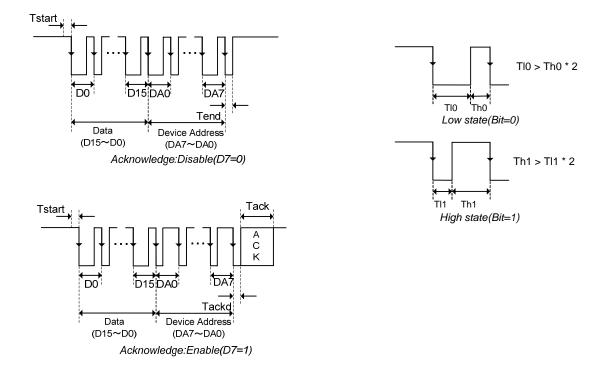


Fig5. Bit detection Diagram

BITE	Register	BIT	Description
	DA7	23(MSB)	1
	DA6	22	0
Device	DA5	21	0
Address	DA4	20	0
(0x8F)	DA3	19	1
(OXOI)	DA2	18	1
	DA1	17	1
	DA0	16	1
	D15	15	Data bit 15 No information. Write 0 to this bit.
	D14	14	Data bit 14 No information. Write 0 to this bit.
	D13	13	Data bit 13 No information. Write 0 to this bit.
	D12	12	Data bit 12 No information. Write 0 to this bit.
	D11	11	Data bit 11 No information. Write 0 to this bit.
	AKct(D10)	10	0 = Acknowledge disabled 1 = Acknowledge enabled
Doto	D9	9	Data bit 9
Data	D8	8	Data bit 8
	D7	7	Data bit 7
	D6	6	Data bit 6
	D5	5	Data bit 5
	D4	4	Data bit 4
	D3	3	Data bit 3
	D2	2	Data bit 2
	D1	1	Data bit 1 LSB of brightness code
	D0	0(LSB)	Data bit 0 No information.

Table1. Bit Description

LED Current setting RT resistor=63.4K $\Omega$  (20mA)

LED current = I(LED\_full) x code/255= LEDO1current=LEDO2current

code	D8	D7	D6	D5	D4	D3	D2	D1	LED Current(mA)
0	0	0	0	0	0	0	0	0	0 Unavailable
1	0	0	0	0	0	0	0	1	0.22
2	0	0	0	0	0	0	1	0	0.30
3	0	0	0	0	0	0	1	1	0.38
4	0	0	0	0	0	1	0	0	0.47
5	0	0	0	0	0	1	0	1	0.55
6	0	0	0	0	0	1	1	0	0.63
7	0	0	0	0	0	1	1	1	0.70
8	0	0	0	0	1	0	0	0	0.78
9	0	0	0	0	1	0	0	1	0.86
10	0	0	0	0	1	0	1	0	0.94
-									
					•				•
246	1	1	1	1	0	1	1	0	19.30
247	1	1	1	1	0	1	1	1	19.38
248	1	1	1	1	1	0	0	0	19.46
249	1	1	1	1	1	0	0	1	19.54
250	1	1	1	1	1	0	1	0	19.61
251	1	1	1	1	1	0	1	1	19.69
252	1	1	1	1	1	1	0	0	19.77
253	1	1	1	1	1	1	0	1	19.84
254	1	1	1	1	1	1	1	0	19.93
255	1	1	1	1	1	1	1	1	20 *Default

Table2. Data Register vs LED current sink

## **PWM Mode**

The dimming mode is set to PWM mode when it is not recognized as a digital mode within Tsel. The LV52207NXA can receive the PWM signals at the PWM pin (PWM interface)(**PWM Mode**) for brightness dimming. When using PWM interface, the EN pin should be kept high. If EN pin is H, PWM pin alone is used to enable and disable the IC. When EN pin is H and PWM pin is H, this IC is enable. When EN pin more than 2.5ms are low or when PWM pin more than 20ms are low, the IC is disable.

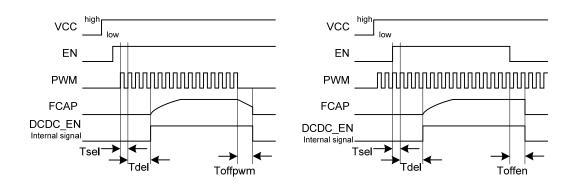


Fig6. Start up and shutdown diagram (PWM MODE)

#### **LEDO1 or LEDO2 UNUSED**

If only one channel is used, a user can be made to OFF by connecting to ground the unused channel. If LEDO1 pin and LEDO2 pin are connected to ground, dcdc will not start up.

## **Over Voltage Protection (SW OVP)**

SW pin over-voltage protection is set at 37.5V. **This IC monitors the Voltage at SW pin**. When the voltage exceed OVP threshold, the switching converter stops switching.

If SW terminal voltage exceeds a threshold Vovp (37.5V typ) for 8 cycles, boost converter enters shutdown mode. In order to restart the IC, SWIRE signal is required again.

#### Over Voltage Protection (LEDO OVP)

LED pin over-voltage protection is set at 4.5V(rise) 3.5V(fall). **This IC monitors the Voltage at LEDO1 pin and LEDO2 pin**. When the voltage exceed LEDO OVP threshold, the switching converter stops switching. LED current sink keep.

#### **Open LED Protection**

< When one LED string becomes open.>

If one LED string is open, open channel voltage is about ground, the boost output voltage is increased and other LEDO channel voltage is increased. When SW pin voltage is reached the SW OVP threshold the LV52207NXA's switching converter stops switching. When other LEDO pin voltage is reached the LEDO OVP threshold, the LV52207NXA's switching converter stops switching.

< When both LED strings become open.>

If both LED strings are open, LEDO1 pin voltage and LEDO2 pin voltage is about ground, and the boost output voltage is increased

When SW pin voltage is reached the SW OVP threshold the LV52207NXA's switching converter stops switching.

#### **Over Current Protection**

Current limit value for built-in power MOS is around 1.5A. The power MOS is turned off for each switching cycle when peak current through it exceeds the limit value.

#### **Under Voltage Lock Out (UVLO)**

UVLO operation works when VIN terminal voltage is below 2.2V.

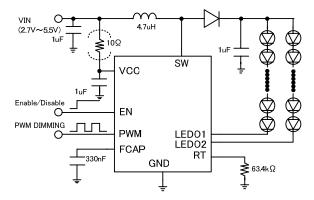
#### **Thermal Shutdown**

When chip temperature is too high, boost converter is stopped.

# **Application Circuit Diagram**

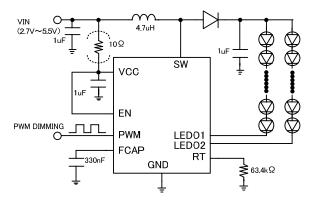
PWM dimming mode

EN pin can be used to enable or disable



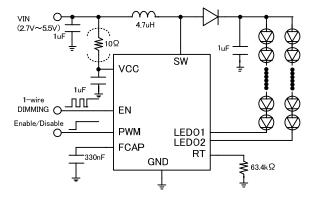
PWM dimming mode

PWM pin can be used to enable or disable



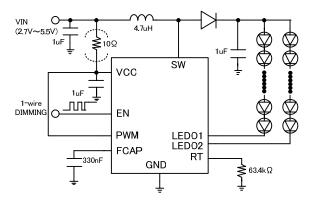
1-wire dimming mode

PWM pin can be used to enable or disable

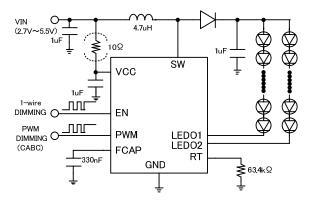


1-wire dimming mode

EN pin can be used to enable or disable



1-wire dimming mode and PWM dimming mode (CABC)



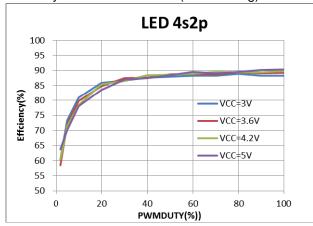
## Notes start-up sequences

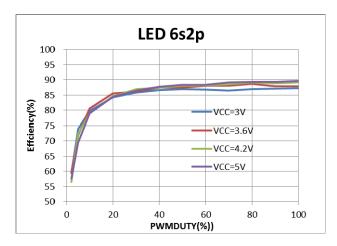
During Tw0 period of 1-wire, it is necessary to make PWM "High".

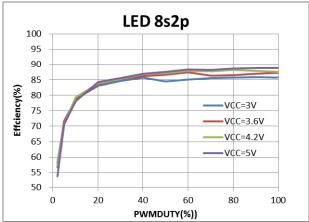
Fig7. Various application circuit diagram

## Typical Characteristics (VIN=3.6V, L=10µH, T=25°C, unless otherwise specified)

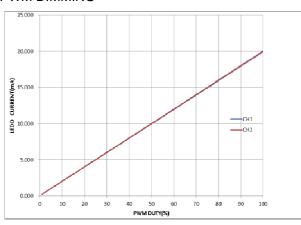
## Efficiency vs PWM DIMMING (20mA/string)



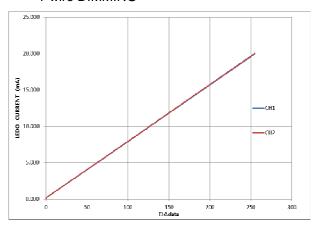




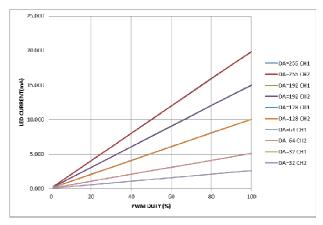
### **PWM DIMMING**



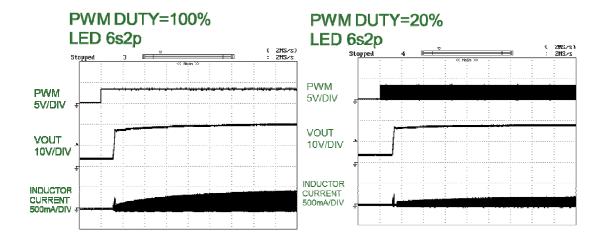
### 1-wire DIMMING



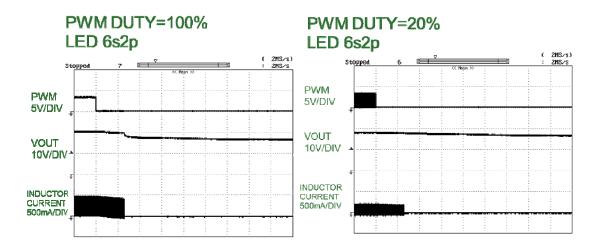
#### **CABC DIMMING**



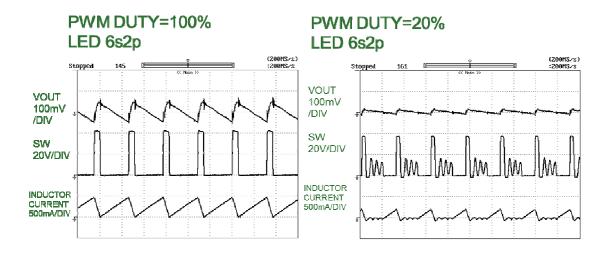
#### START UP WAVEFORM



#### SHUTDOWN WAVEFORM



#### **SWITCHING WAVEFORM**

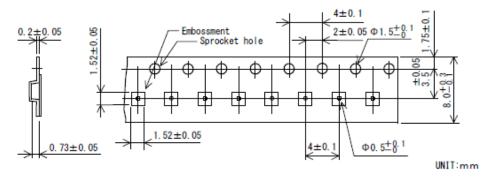


## Packing Specification of Embossed Carrier Taping

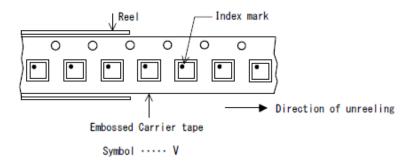
#### WLP9 (1.31X1.31)

#### 1. EMBOSS CARRIER TAPING

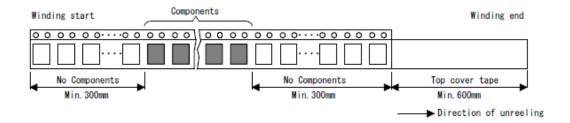
1-1. Emboss carrier tape dimensions



#### 1-2. Tape mounting direction



#### 1-3. Reel winding start and reel winding end



#### 2. TAPE STRENGTH

2-1. Tensile strength of the carrier tape : Min. 10N

2-2. Peel strength of the top cover tape

(a)Peel angle: 165° to 180° relative to the tape adhesive surface

(b)Peel rate: 300mm / minute (c)Peel of strength: 0.1N to 1.0N

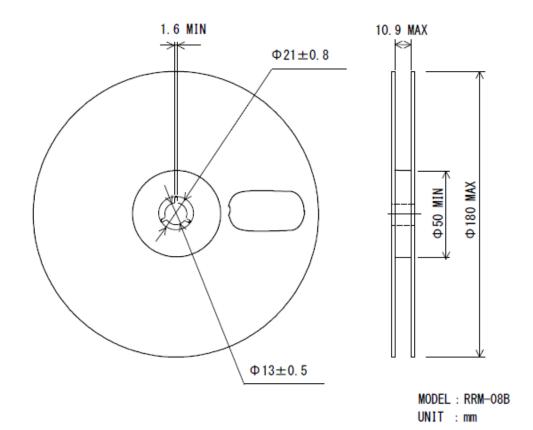
# Packing Specification of Embossed Carrier Taping

WLP9 (1.31X1.31)

#### 3. PARTS No. ON BAR CODE LABEL



#### 4. REEL DIMENSIONS

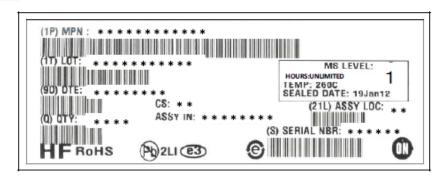


# Packing Specification of Embossed Carrier Taping

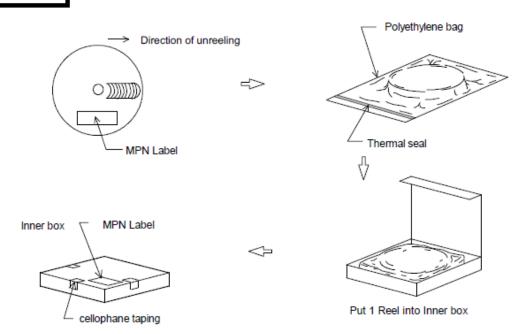
## WLP9 (1.31X1.31)

Carrier tape type number	Package code	Maximum number of ICs contained (pcs.)		Packing form
Lype Humber		Reel	Inner box	Inner box. B0X (TE-1208)
CARR (BD0145X0145)	WLP9 (1. 31X1. 31)	5, 000	5, 000	1 Reels contained Dimensions:mm 190×37×190

## MPN Label



#### Packing Method



#### ORDERING INFORMATION

Device	Package	Shipping (Qty / Packing)
LV52207NXA-VH	WLP9 (1.31×1.31) (Pb-Free / Halogen Free)	5000 / Tape & Reel

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